



BAS21QC

High-voltage switching diode

27 November 2020

Product data sheet

1. General description

High-voltage switching diode, encapsulated in an ultra small DFN1412D-3 (SOT8009, JEDEC MO340-CA) leadless Surface-Mounted Device (SMD) plastic package with side-wettable flanks.

2. Features and benefits

- High switching speed: $t_{rr} \leq 50$ ns
- Low leakage current
- High reverse voltage: $V_R \leq 200$ V
- Low capacitance: $C_d \leq 5$ pF
- Leadless ultra small SMD plastic package
- Low package height of 0.5 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- AEC-Q101 qualified

3. Applications

- High-speed switching
- General-purpose switching
- Voltage clamping
- Reverse polarity protection

4. Quick reference data

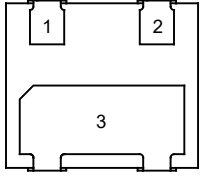
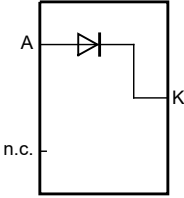
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I_F	forward current	$T_j = 25$ °C	[1]	-	-	250	mA
V_R	reverse voltage			-	-	200	V
V_F	forward voltage	$I_F = 200$ mA; $T_j = 25$ °C		-	-	1.25	V
V_{RRM}	repetitive peak reverse voltage	$T_j = 25$ °C		-	-	250	V
I_R	reverse current	$V_R = 200$ V; $T_j = 25$ °C		-	-	100	nA
t_{rr}	reverse recovery time	$I_F = 30$ mA; $I_R = 30$ mA; $R_L = 100$ Ω; $I_{R(meas)} = 3$ mA; $T_{amb} = 25$ °C		-	-	50	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70 μm copper, tin-plated and standard footprint.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A	anode	 <p>Bottom view DFN1412D-3 (SOT8009)</p>	 <p>aaa-021941</p>
2	n.c.	not connected		
3	K	cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAS21QC	DFN1412D-3	plastic, leadless extremely thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.8 mm pitch; 1.4 mm x 1.2 mm x 0.48 mm body	SOT8009

7. Marking

Table 4. Marking codes

Type number	Marking code
BAS21QC	9Q

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134)

Symbol	Parameter	Conditions		Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage	$T_j = 25\text{ °C}$		-	250	V
V_R	reverse voltage			-	200	V
I_F	forward current		[1]	-	250	mA
I_{FSM}	non-repetitive peak forward current	$t_p = 1\ \mu\text{s}$; square wave; $T_{j(\text{init})} = 25\text{ °C}$		-	9	A
		$t_p = 100\ \mu\text{s}$; square wave; $T_{j(\text{init})} = 25\text{ °C}$		-	3	A
		$t_p = 10\ \text{ms}$; square wave; $T_{j(\text{init})} = 25\text{ °C}$		-	1.7	A
I_{FRM}	repetitive peak forward current	$t_p \leq 1\ \text{ms}$; $\delta \leq 0.25$		-	625	mA
P_{tot}	total power dissipation	$T_{\text{amb}} \leq 25\text{ °C}$	[1]	-	440	mW
			[2]	-	750	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70 μm copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70 μm copper, tin-plated and mounting pad for cathode 1 cm^2 .

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	In free air	[1]	-	-	285	K/W
			[2]	-	-	160	K/W

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70 μm copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided 70 μm copper, tin-plated and mounting pad for cathode 1 cm^2 .

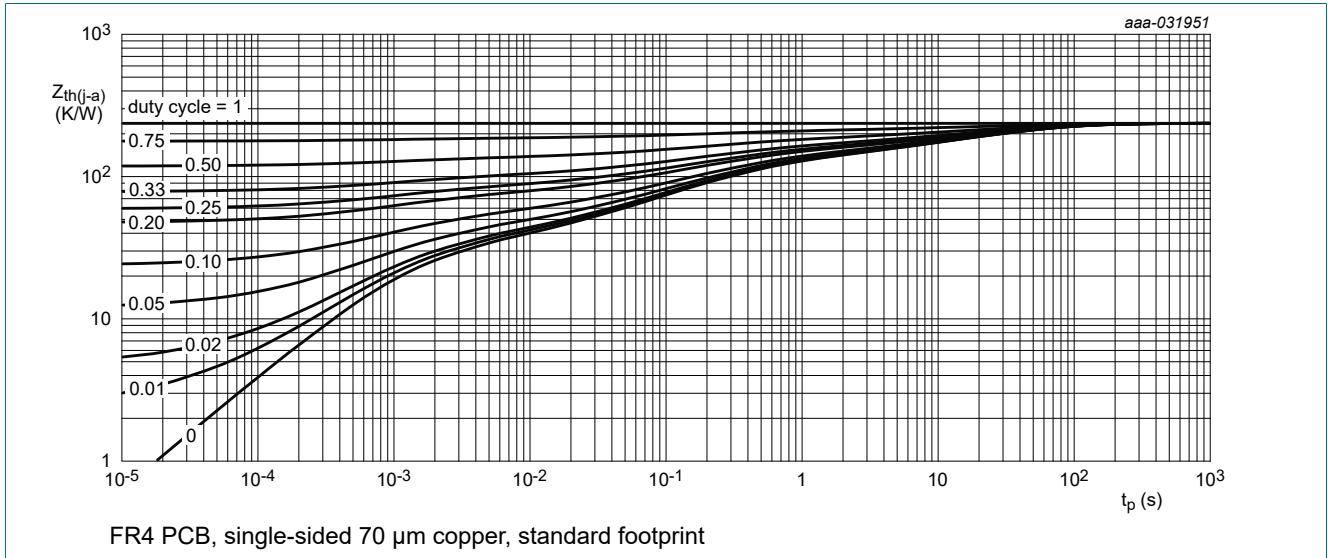


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

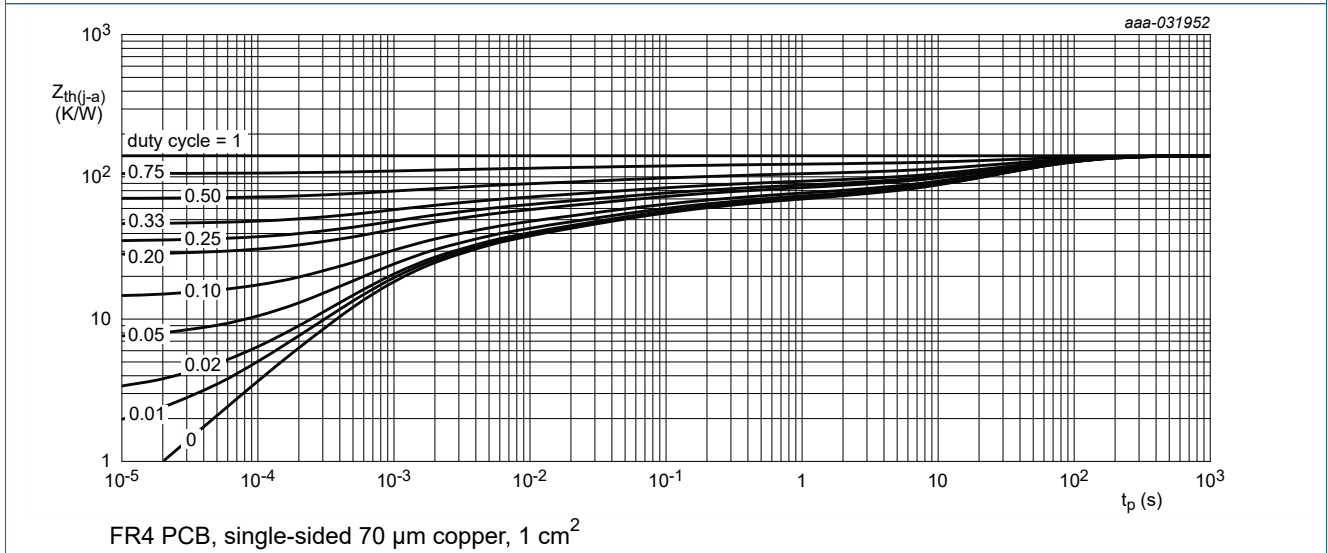
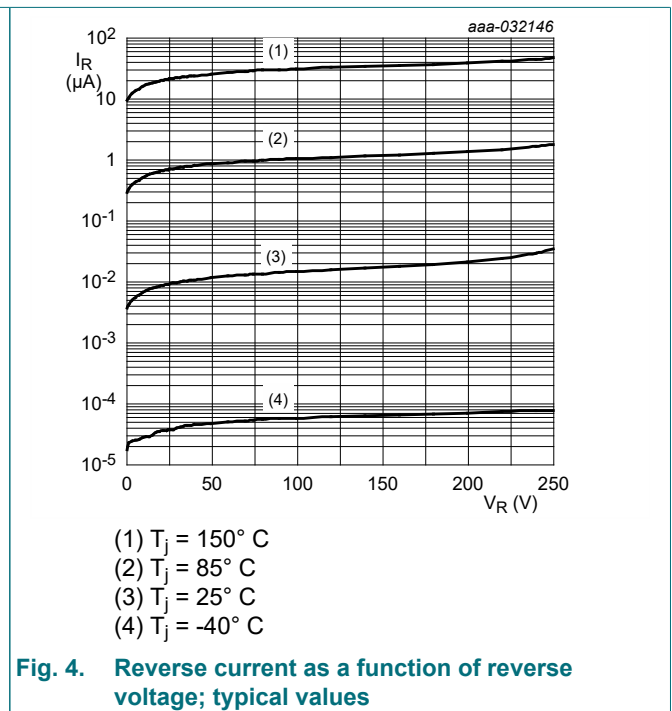
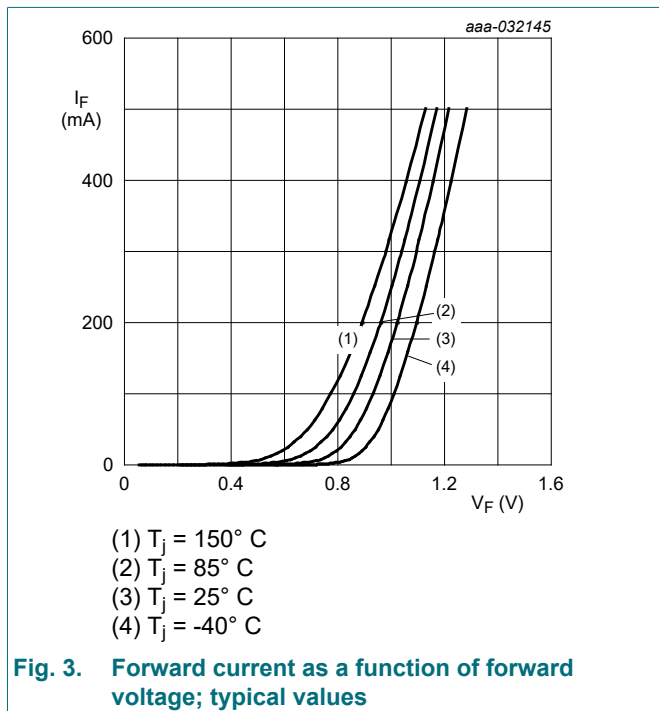


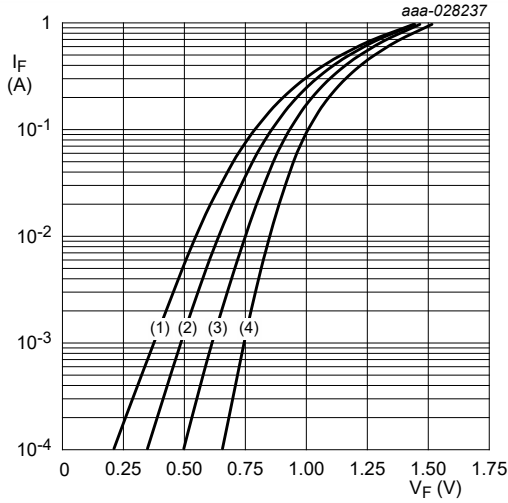
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

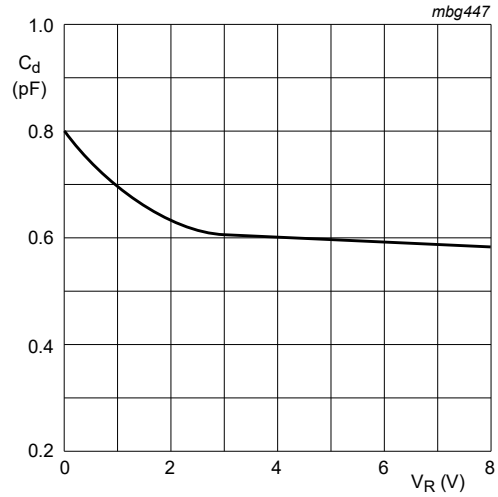
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_F	forward voltage	$I_F = 100 \text{ mA}; T_j = 25 \text{ }^\circ\text{C}$	-	-	1	V
		$I_F = 200 \text{ mA}; T_j = 25 \text{ }^\circ\text{C}$	-	-	1.25	V
I_R	reverse current	$V_R = 200 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	-	100	nA
		$V_R = 200 \text{ V}; T_j = 150 \text{ }^\circ\text{C}$	-	-	100	μA
C_d	diode capacitance	$V_R = 0 \text{ V}; f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	5	pF
t_{rr}	reverse recovery time	$I_F = 30 \text{ mA}; I_R = 30 \text{ mA}; R_L = 100 \text{ } \Omega;$ $I_{R(\text{meas})} = 3 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	50	ns





- (1) $T_j = 150^\circ\text{C}$
- (2) $T_j = 85^\circ\text{C}$
- (3) $T_j = 25^\circ\text{C}$
- (4) $T_j = -40^\circ\text{C}$

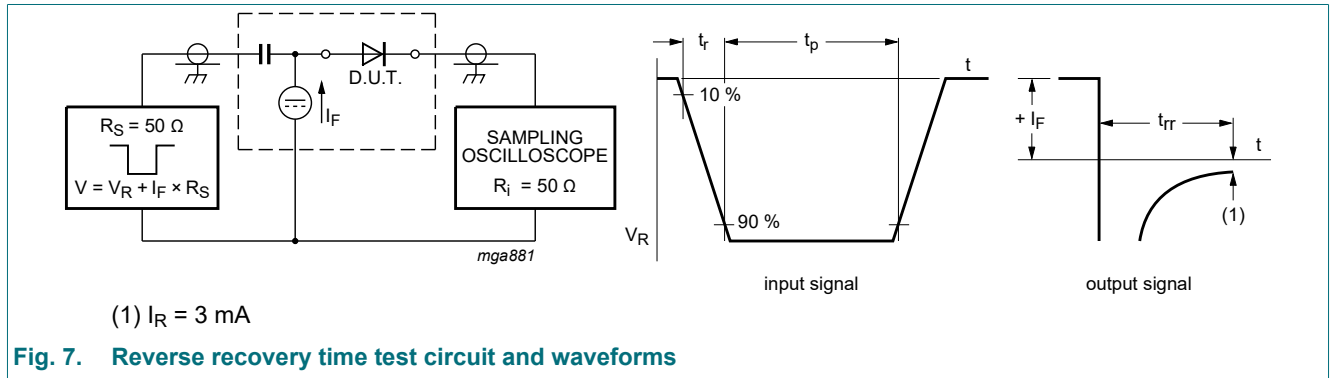
Fig. 5. Forward current as a function of forward voltage; typical values; (logarithmic scale)



$f = 1\text{ MHz}$
 $T_j = 25^\circ\text{C}$.

Fig. 6. Diode capacitance as a function of reverse voltage; typical values.

11. Test information



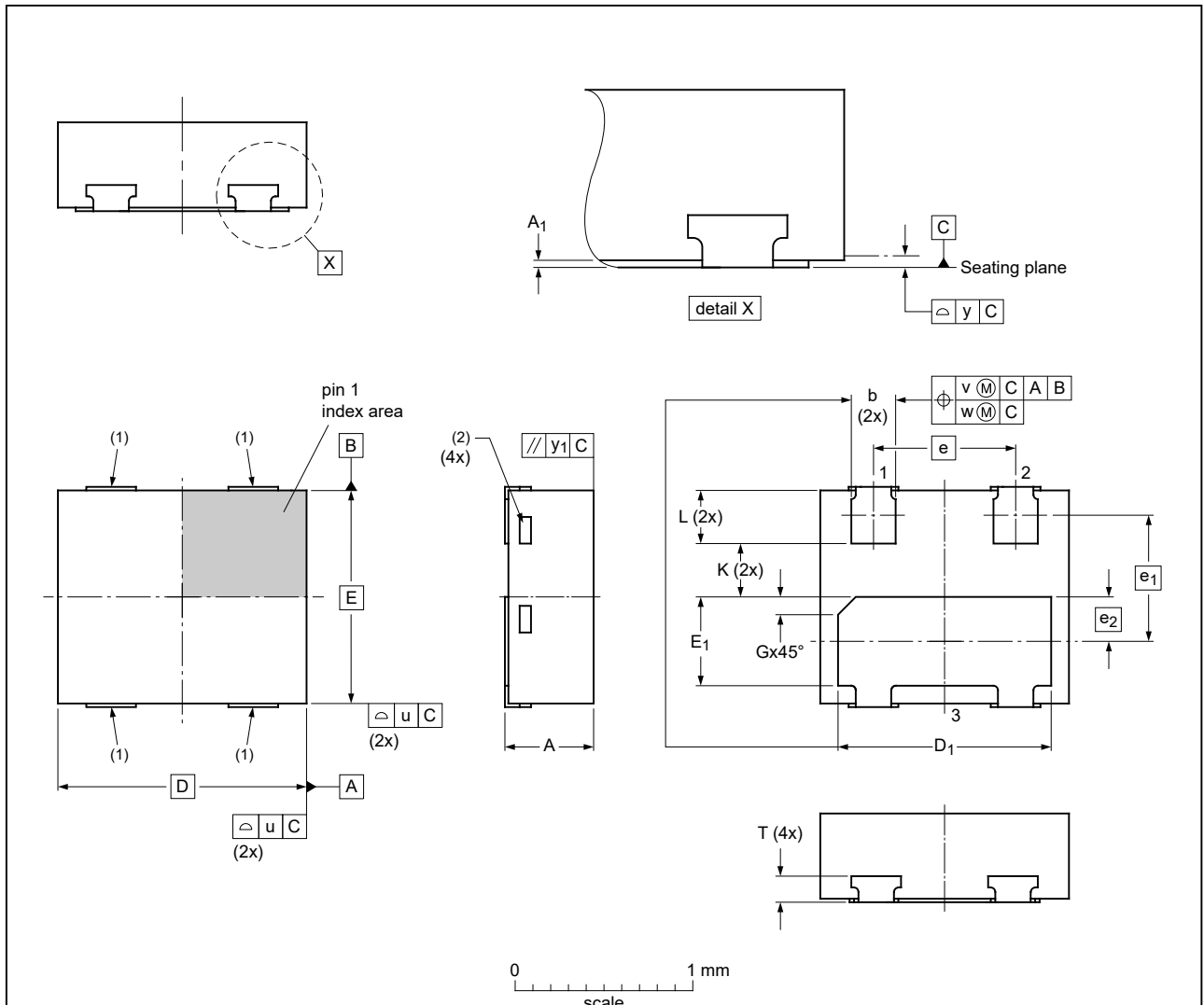
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

DFN1412D-3: plastic, leadless extremely thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.8 mm pitch; 1.4 mm x 1.2 mm x 0.48 mm body

SOT8009



Dimensions (mm are the original dimensions)

Unit	A	A ₁	b	D	D ₁	E	E ₁	e	e ₁	e ₂	G	K	L	T	u	v	w	y	y ₁
max	0.50	0.04	0.30	1.4	1.25	1.2	0.55	0.8	0.71	0.26	0.09		0.35	0.22		0.1	0.05	0.05	0.05
nom	0.47		0.25	1.4	1.20	1.2	0.50	0.8	0.71	0.26	(ref)		0.30	0.16	0.05	0.1	0.05	0.05	0.05
min	0.44		0.22	1.17	1.17	0.47						0.25	0.27	0.10					

Note

- Side Wettable Flank, protrusion max. 0.02 mm.
 - Visible depend upon used manufacturing technology.
- Dimension A and T are including plating thickness.

sot8009_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT8009		MO-340CA				19-12-04 19-12-06

Fig. 8. Package outline DFN1412D-3 (SOT8009)

13. Soldering

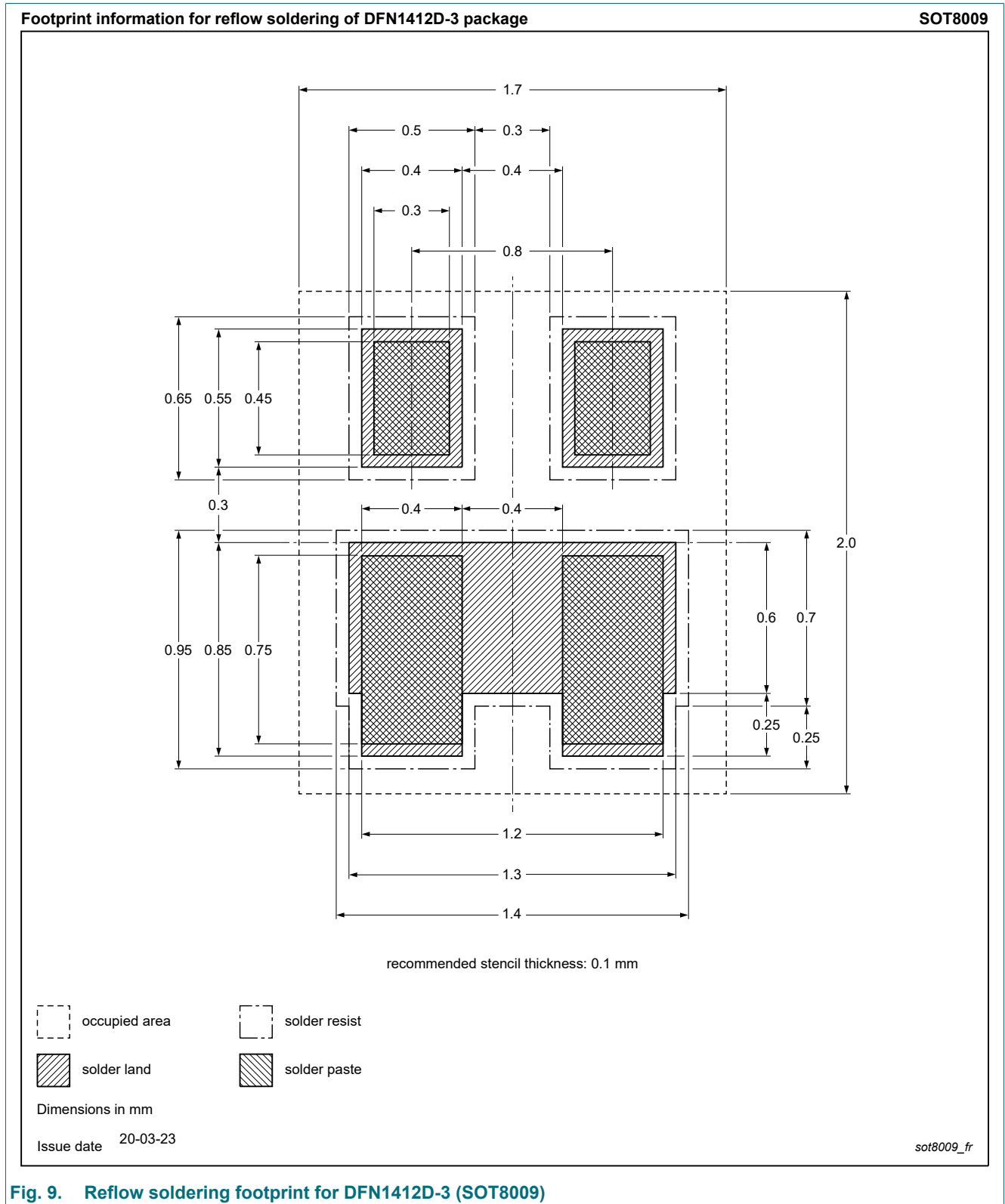


Fig. 9. Reflow soldering footprint for DFN1412D-3 (SOT8009)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAS21QC v.1	20201127	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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